Switching Diode

#### DA3X101A0L

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**Panasonic** 

#### Silicon epitaxial planar type

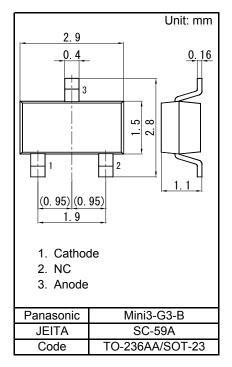
For high speed switching circuits DA3J101A in Mini3 type package

#### ■ Features

- · Small reverse current IR
- Short reverse recovery time trr
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: 20

#### ■ Packaging

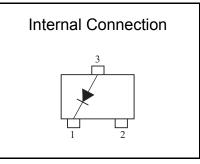
Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Reverse voltage	VR	80	V
Maximum peak reverse voltage	VRM	80	V
Forward current	IF	100	mA
Peak forward current	IFM	225	mA
Non-repetitive peak forward surge current *1	IFSM	500	mA
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C

Note) \*1: t = 1 s



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Established: 2009-11-06 Revised: 2013-06-12 Revision. 4

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#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

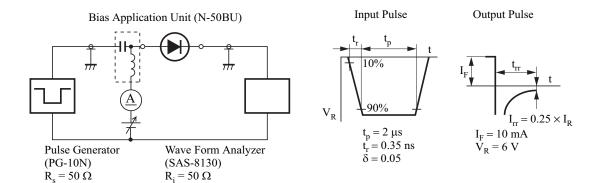
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 100 mA		0.92	1.20	V
Reverse voltage	VR	IR = 100 μA	80			V
Reverse current	IR	VR = 80 V			100	nA
Terminal capacitance	Ct	VR = 0 V , f = 1 MHz			1.2	pF
Reverse recovery time *1	trr	IF = 10 mA, VR = 6 V			3	ns
		Irr = 0.25 x IR			3	

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
  - 2. Absolute frequency of input and output is 100 MHz.
    - 3. \*1: trr test circuit

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Revised

: 2013-06-12

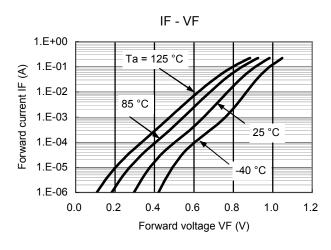


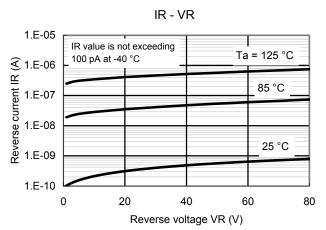
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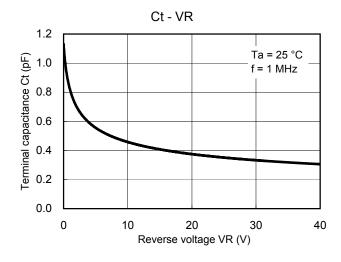
Switching Diode

#### DA3X101A0L

## Technical Data (reference)







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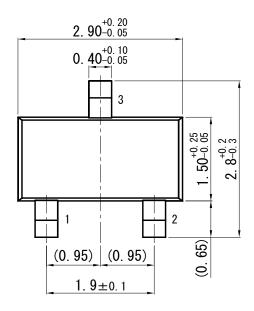
Switching Diode

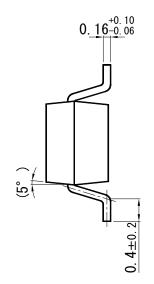
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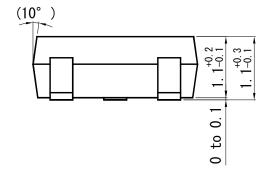
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Mini3-G3-B

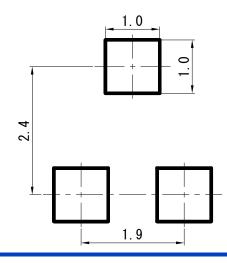
Unit: mm







#### ■ Land Pattern (Reference) (Unit: mm)



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